IDT

LOW SKEW TTL PLL CLOCK DRIVER WITH INTEGRATED LOOP FILTER
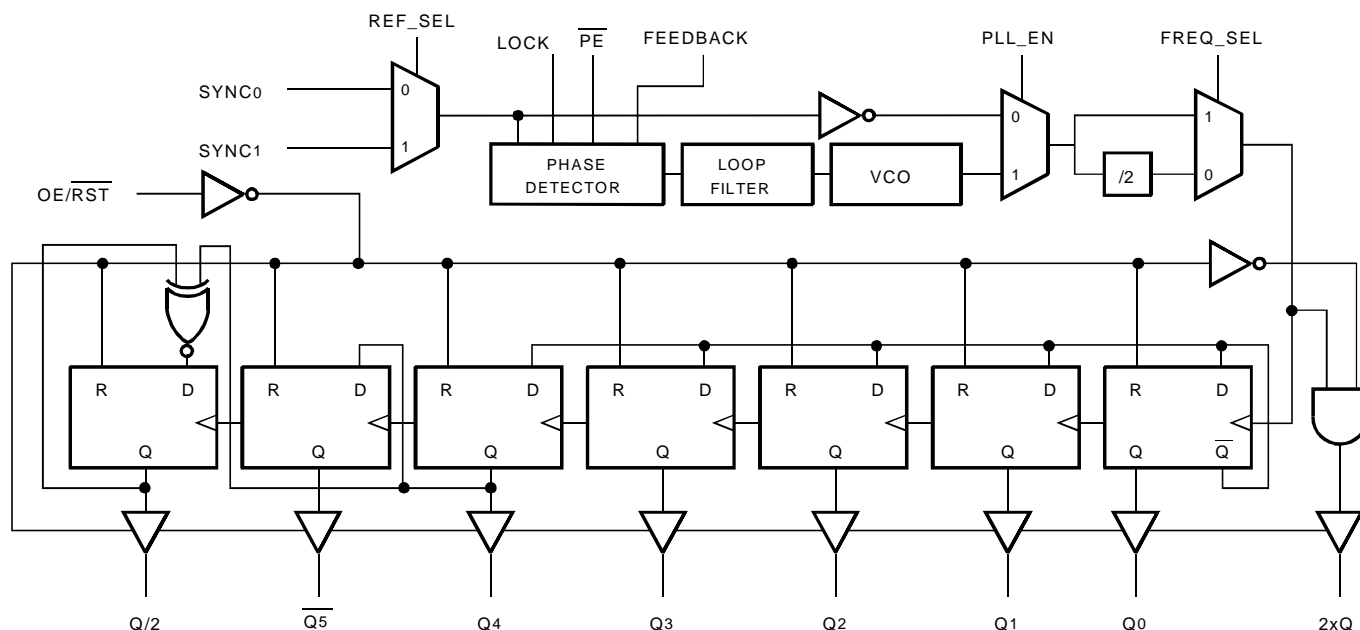
QS5919T

FEATURES:

- 5V operation
- Low noise TTL level outputs
- < 350ps output skew, Q_0–Q_4
- 2xQ output, Q outputs, $\overline{Q}$ output, Q/2 output
- Outputs 3-state and reset while OE/$\overline{RST}$ low
- PLL disable feature for low frequency testing
- Internal loop filter RC network
- Functional equivalent to Motorola MC88915
- Positive or negative edge synchronization ($\overline{PE}$)
- Balanced drive outputs ±24mA
- 160MHz maximum frequency (2xQ output)
- Available in QSOP and PLCC packages
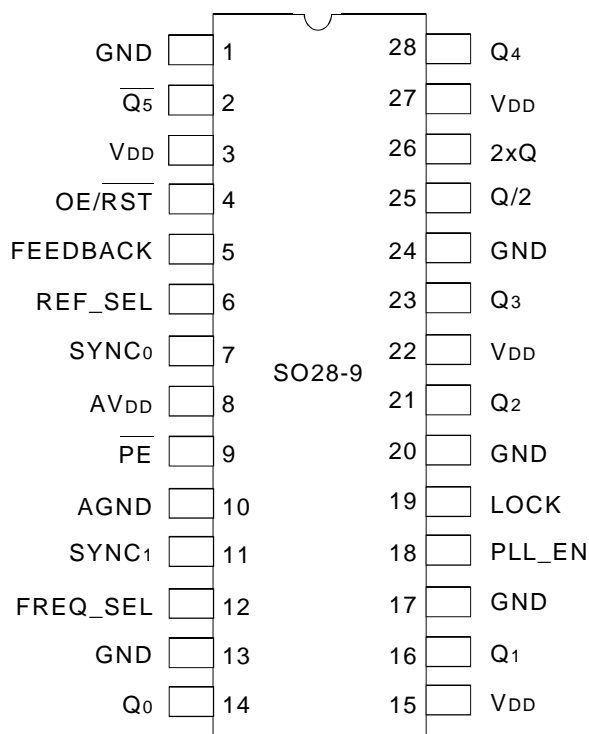
DESCRIPTION

The QS5919T Clock Driver uses an internal phase locked loop (PLL) to lock low skew outputs to one of two reference clock inputs. Eight outputs are available: 2xQ, Q_0-Q_4, $\overline{Q5}$, Q/2. Careful layout and design ensure < 350ps skew between the Q_0-Q_4, and Q/2 outputs. The QS5919T includes an internal RC filter which provides excellent jitter characteristics and eliminates the need for external components. Various combinations of feedback and a divide-by-2 in the VCO path allow applications to be customized for linear VCO operation over a wide range of input SYNC frequencies. The PLL can also be disabled by the PLL_EN signal to allow low frequency or DC testing. The LOCK output asserts to indicate when phase lock has been achieved. The QS5919T is designed for use in high-performance workstations, multi-board computers, networking hardware, and mainframe systems. Several can be used in parallel or scattered throughout a system for guaranteed low skew, system-wide clock distribution networks.

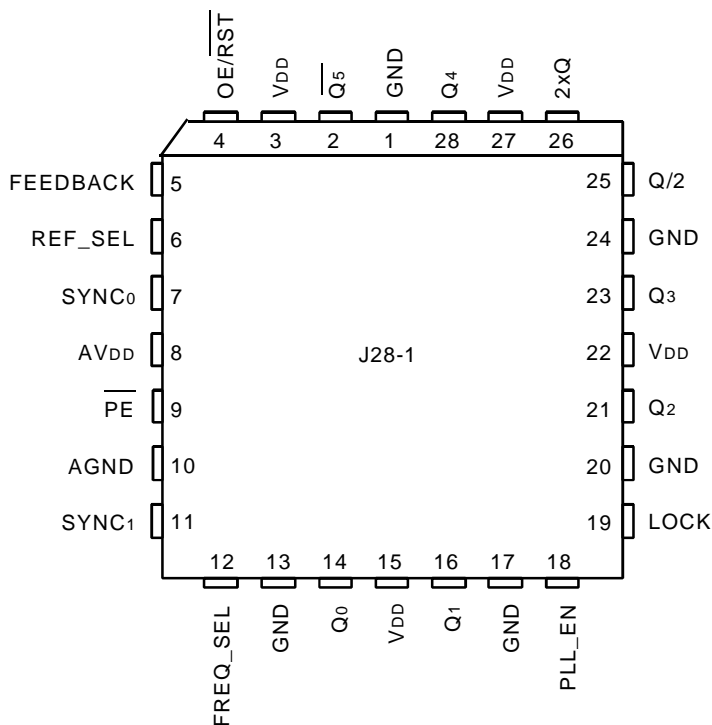For more information on PLL clock driver products, see Application Note AN-227.

FUNCTIONAL BLOCK DIAGRAM

DSC-5815/-

PIN CONFIGURATION

QSOP
TOP VIEW

GND	1	28	Q4
$\overline{Q_5}$	2	27	VDD
VDD	3	26	2xQ
OE/$\overline{RST}$	4	25	Q/2
FEEDBACK	5	24	GND
REF_SEL	6	23	Q3
SYNC0	7	22	VDD
AVDD	8	21	Q2
$\overline{PE}$	9	20	GND
AGND	10	19	LOCK
SYNC1	11	18	PLL_EN
FREQ_SEL	12	17	GND
GND	13	16	Q1
Q0	14	15	VDD

SO28-9

PLCC
TOP VIEW

J28-1

ABSOLUTE MAXIMUM RATINGS [1]

Symbol	Rating		Max.	Unit
VDD, AVDD	Supply Voltage to Ground		−0.5 to +7	V
VIN	DC Input Voltage VIN		−0.5 to +7	V
	Maximum Power	QSOP	655	mW
	Dissipation (TA = 85°C)	PLCC	770	mW
TSTG	Storage Temperature Range		−65°C to +150°C	°C

NOTE:
1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

CAPACITANCE (TA = 25°C, f = 1MHz, VIN = 0V)

Parameter	QSOP		PLCC		Unit
	Typ.	Max.	Typ.	Max.	
CIN	3	4	4	6	pF

PIN DESCRIPTION

Pin Name	I/O	Description
$SYNC_0$	I	Reference clock input
$SYNC_1$	I	Reference clock input
REF_SEL	I	Reference clock select. When 1, selects $SYNC_1$. When 0, selects $SYNC_0$.
FREQ_SEL	I	VCO frequency select. For choosing optimal VCO operating frequency depending on input frequency.
FEEDBACK	I	PLL feedback input which is connected to a user selected output pin. External feedback provides flexibility for different output frequency relationships. See the Frequency Selection Table for more information.
Q_0 -Q_4	O	Clock outputs
$\overline{Q_5}$	O	Clock output. Matched in frequency, but inverted with respect to Q.
2xQ	O	Clock output. Matched in phase, but frequency is double the Q frequency.
Q/2	O	Clock output. Matched in phase, but frequency is half the Q frequency.
LOCK	O	PLL lock indication signal. 1 indicates positive lock. 0 indicates that the PLL is not locked and outputs may not be synchronized to the inputs.
OE/$\overline{RST}$	I	Output enable/asynchronous reset. Resets all output registers. When 0, all outputs are held in a tri-stated condition. When 1, outputs are enabled.
PLL_EN	I	PLL enable. Enables and disables the PLL. Useful for testing purposes.
$\overline{PE}$	I	When $\overline{PE}$ is LOW, outputs are synchronized with the positive edge of SYNC. When HIGH, outputs are synchronized with the negative edge of SYNC.
V_{DD}	—	Power supply for output buffers.
AV_{DD}	—	Power supply for phase lock loop and other internal circuitries.
GND	—	Ground supply for output buffers.
AGND	—	Ground supply for phase lock loop and other internal circuitries.

OUTPUT FREQUENCY SPECIFICATIONS

Industrial: T_A = –40°C to +85°C, AV_{DD} / V_{DD} = 5.0V ± 10%

Symbol	Description	– 55	– 70	– 100	– 133	– 160	Units
F_{MAX_2XQ}	Max Frequency, 2xQ	55	70	100	133	160	MHz
F_{MAX_Q}	Max Frequency, Q_0 - Q_4, $\overline{Q_5}$	27.5	35	50	66.5	80	MHz
$F_{MAX\_Q/2}$	Max Frequency, Q/2	13.75	17.5	25	33.25	40	MHz
F_{MIN_2XQ}	Min Frequency, 2xQ	20	20	20	20	20	MHz
F_{MIN_Q}	Min Frequency, Q_0 - Q_4, $\overline{Q_5}$	10	10	10	10	10	MHz
$F_{MIN\_Q/2}$	Min Frequency, Q/2	5	5	5	5	5	MHz

FREQUENCY SELECTION TABLE

FREQ_SEL	Output Used for Feedback	SYNC (MHz) (allowable range) [1]		Output Frequency Relationships [2]			
		Min.	Max	Q/2	$\overline{Q_5}$	$Q_0 - Q_4$	2XQ
HIGH	Q/2	$F_{MIN\_Q/2}$	$F_{MAX\_Q/2}$	SYNC	– SYNC X 2	SYNC X 2	SYNC X 4
HIGH	$Q_0 - Q_4$	F_{MIN_Q}	F_{MAX_Q}	SYNC / 2	– SYNC	SYNC	SYNC X 2
HIGH	$\overline{Q_5}$	F_{MIN_Q}	F_{MAX_Q}	– SYNC / 2	SYNC	– SYNC	– SYNC X 2
HIGH	2xQ	F_{MIN_2XQ}	F_{MAX_2XQ}	SYNC / 4	– SYNC / 2	SYNC / 2	SYNC
LOW	Q/2	$F_{MIN\_Q/2}$ /2	$F_{MAX\_Q/2}$ /2	SYNC	– SYNC X 2	SYNC X 2	SYNC X 4
LOW	$Q_0 - Q_4$	F_{MIN_Q} /2	F_{MAX_Q} /2	SYNC / 2	– SYNC	SYNC	SYNC X 2
LOW	$\overline{Q_5}$	F_{MIN_Q} /2	F_{MAX_Q} /2	– SYNC / 2	SYNC	– SYNC	– SYNC X 2
LOW	2xQ	F_{MIN_2XQ} /2	F_{MAX_2XQ} /2	SYNC / 4	– SYNC / 2	SYNC / 2	SYNC

NOTES:

1. Operation in the specified SYNC frequency range guarantees that the VCO will operate in its optimal range of 20MHz to F_{MAX_2xQ}. Operation with Sync inputs outside specified frequency ranges may result in out-of-lock outputs. FREQ_SEL only affects VCO frequency and does not affect output frequencies.
2. The lock output pin (LOCK) may not indicate reliably for VCO frequencies below 30MHz.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Industrial: T_A = –40°C to +85°C, AV_{DD} / V_{DD} = 5.0V ± 10%

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level	2	—	—	V
V_{IL}	Input LOW Voltage	Guaranteed Logic LOW Level	—	—	0.8	V
V_{OH}	Output HIGH Voltage	V_{DD} = Min., I_{OH} = –24mA	2.4	—	—	V
		V_{DD} = Min., I_{OH} = –100µA	3	—	—	V
V_{OL}	Output LOW Voltage	V_{DD} = Min., I_{OL} = 24mA	—	—	0.45	V
		V_{DD} = Min., I_{OL} = 100µA	—	—	0.2	V
V_H	Input Hysteresis	—	—	100	—	mV
I_{OZ}	Output Leakage Current	V_{OUT} = V_{DD} or GND, V_{DD} = Max.	—	—	5	µA
I_{IN}	Input Leakage Current	V_{IN} = AV_{DD} or GND, AV_{DD} = Max.	—	—	5	µA
I_{PD}	Input Pull-Down Current ($\overline{PE}$)	AV_{DD} = Max., V_{IN} = AV_{DD}	—	—	100	µA

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions	Typ.	Max.	Unit
I_{DDQ}	Quiescent Power Supply Current	V_{DD} = Max., OE/$\overline{RST}$ = LOW, SYNC = LOW, All outputs unloaded		1.5	mA
ΔI_{DD}	Power Supply Current per Input HIGH	V_{DD} = Max., V_{IN} = 3.4V	0.5	1.5	mA
I_{DDD}	Dynamic Power Supply Current [1]	V_{DD} = Max., C_L = 0pF	0.2	0.4	mA/MHz

NOTE:

1. Relative to the frequency of Q outputs.

INPUT TIMING REQUIREMENTS

Symbol	Description [1]	Min.	Max.	Unit
t_R, t_F	Maximum input rise and fall times, 0.8V to 2V	—	3	ns
F_I	Input Clock Frequency, $SYNC_0$, $SYNC_1$ [1]	2.5	F_{MAX_2XQ}	MHz
t_{PWC}	Input clock pulse, HIGH or LOW [2]	2	—	ns
D_H	Input duty cycle [2]	25	75	%

NOTES:
1. See Output Frequency and Frequency Selection tables for more detail on allowable SYNC input frequencies for different speed grades with different FEEDBACK and FREQ_SEL combinations.
2. Where pulse witdh implied by D_H is less than t_{WPC} limit, t_{WPC} limit applies
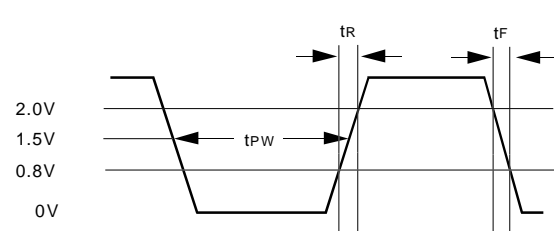
SWITCHING CHARACTERISTICS OVER OPERATING RANGE

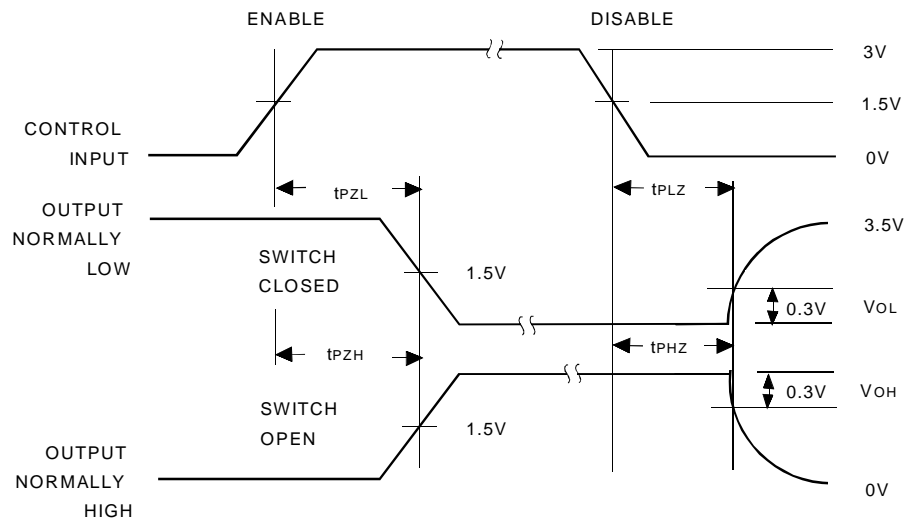| Symbol	Parameter [1]	Min.	Max.	Unit
t_{SKR}	Output Skew Between Rising Edges, Q_0-Q_4 and Q/2 [2]	—	350	ps
t_{SKF}	Output Skew Between Falling Edges, Q_0-Q_4 and Q/2 [2]	—	350	ps
t_{SKALL}	Output Skew, All Outputs [2,5]	—	500	ps
t_{PW}	Pulse Width, 2xQ output, >40MHz	$T_{CY}/2 - 0.4$	$T_{CY}/2 + 0.4$	ns
t_{PW}	Pulse Width, Q_0-Q_4, $\overline{Q_5}$, Q/2 outputs, 80MHz	$T_{CY}/2 - 0.4$	$T_{CY}/2 + 0.4$	ns
t_J	Cycle-to-Cycle Jitter [4]	-0.15	0.15	ns
t_{PD}	SYNC Input to Feedback Delay [6]	-500	0	ps
t_{LOCK}	SYNC to Phase Lock	—	10	ms
t_{PZH} t_{PZL}	Output Enable Time, OE/$\overline{RST}$ LOW to HIGH [3]	0	7	ns
t_{PHZ} t_{PLZ}	Output Enable Time, OE/$\overline{RST}$ HIGH to LOW [3]	0	6	ns
t_R, t_F	Output Rise/Fall Times, 0.8V ~ 2V	0.3	1.5	ns

NOTES:
1. See Test Loads and Waveforms for test load and termination. Test circuit 1 is used for output enable/disable parameters. Test circuit 2 is used for all other timing parameters.
2. Skew specifications apply under identical environments (loading, temperature, VCC, device speed grade).
3. Measured in open loop mode PLL_EN = 0.
4. Jitter is characterized with Q output at 20MHz. See FREQUENCY SELECTION TABLE for information on proper FREQ_SEL level for specified input frequencies.
5. Skew measured at selected synchronization edge.
6. t_{PD} measured at device inputs at 1.5V, Q output at 80MHz.

AC TEST LOADS AND WAVEFORMS

TEST CIRCUIT 1

300Ω

7.0V

OUTPUT

30pF

300Ω

TEST CIRCUIT 2

V_{DD}

160Ω

OUTPUT

68Ω

20pF

1.0ns 1.0ns

3.0V
2.0V
V_{th} = 1.5V
0.8V
0V

TTL INPUT TEST WAVEFORM

t_R t_F

2.0V
1.5V
0.8V
0V

t_{PW}

TTL OUTPUT WAVEFORM

ENABLE DISABLE

CONTROL INPUT

3V
1.5V
0V

OUTPUT NORMALLY LOW

t_{PZL}

t_{PLZ}

SWITCH CLOSED

1.5V

3.5V

0.3V V_{OL}

t_{PZH}

t_{PHZ}

SWITCH OPEN
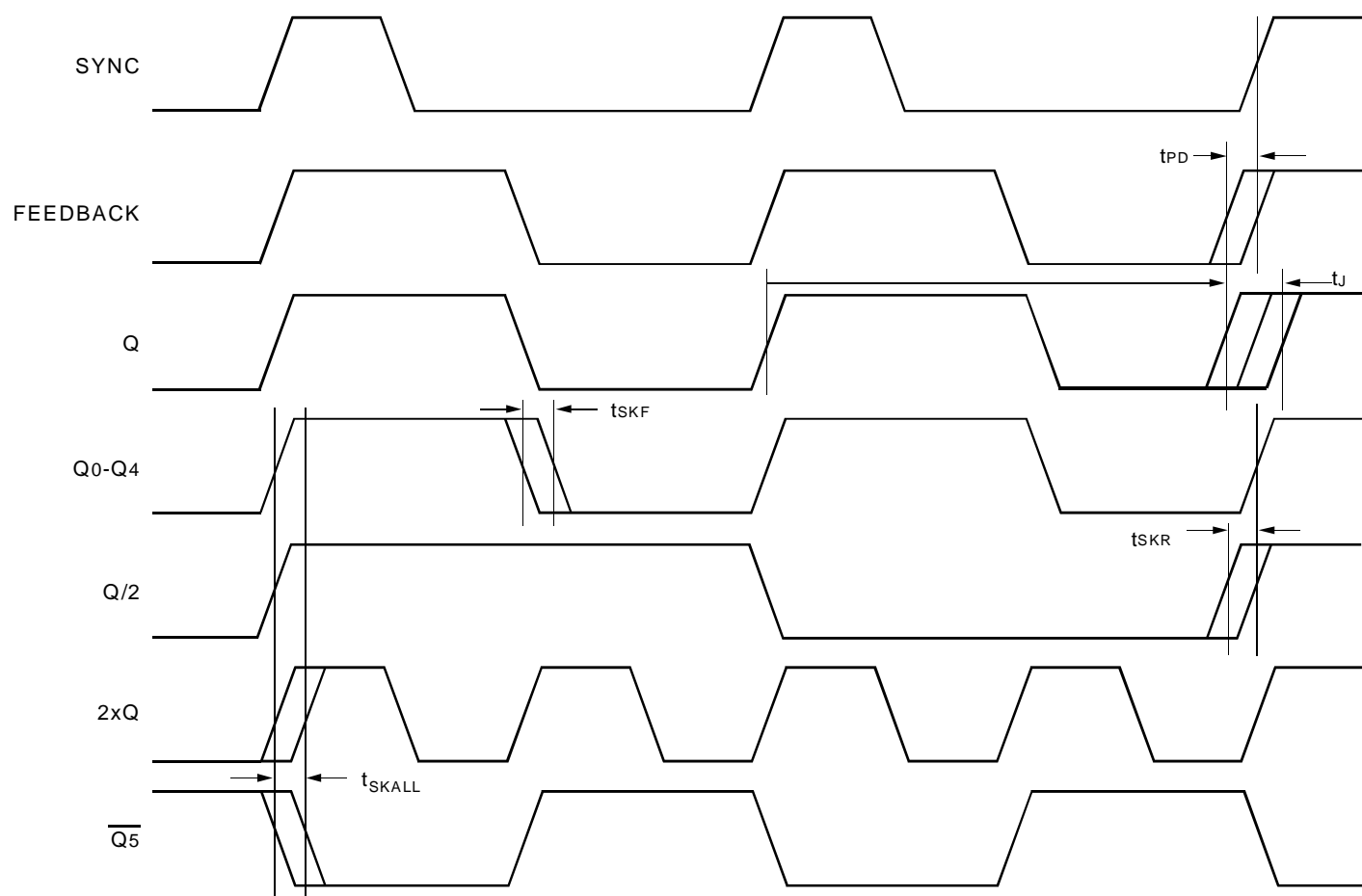
1.5V

0.3V V_{OH}

OUTPUT NORMALLY HIGH

0V

ENABLE AND DISABLE TIMES

TEST CIRCUIT 1 is used for output enable/disable parameters.
TEST CIRCUIT 2 is used for all other timing parameters.

AC TIMING DIAGRAM

NOTES:

1. AC Timing Diagram applies to Q output connected to FEEDBACK and $\overline{PE}$ = GND. For $\overline{PE}$ = V$_{DD}$, the negative edge of FEEDBACK aligns with the negative edge of SYNC input, and the negative edges of the multiplied and divided outputs align with the negative edge of SYNC.

2. All parameters are measured at 1.5V.

PLL OPERATION

The Phase Locked Loop (PLL) circuit included in the QS5919T provides for replication of incoming SYNC clock signals. Any manipulation of that signal, such as frequency multiplying or inversion is performed by digital logic following the PLL (see the block diagram). The key advantage of the PLL circuit is to provide an effective zero propagation delay between the output and input signals. In fact, adding delay circuits in the feedback path, 'propagation delay' can even be negative! A simplified schematic of the QS5919T PLL circuit is shown below.

SIMPLIFIED DIAGRAM OF QS5919T FEEDBACK
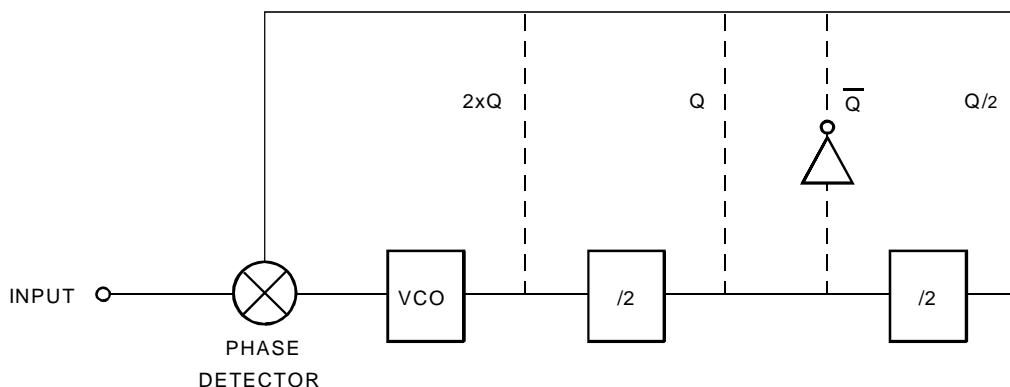
The phase difference between the output and the input frequencies feeds the VCO which drives the outputs. Whichever output is fed back, it will stabilize at the same frequency as the input. Hence, this is a true negative feedback closed loop system. In most applications, the output will optimally have zero phase shift with respect to the input. In fact, the internal loop filter on the QS5919T typically provides within 150ps of phase shift between input and output.

If the user wishes to vary the phase difference (typically to compensate for backplane delays), this is most easily accomplished by adding delay circuits to the feedback path. The respective output used for feedback will be advanced by the amount of delay in the feedback path. All other outputs will retain their proper relationships to that output.

ORDERING INFORMATION

QS   <u>XXXX</u>   <u>XX</u>   <u> X </u>
    Device Type   Speed   Package

Q	Quarter Size Outline Package (SO28-9)
J	Plastic Leaded Chip Carrier (J28-1)

55	55MHz Max. Frequency
70	70MHz Max. Frequency
100	100MHz Max. Frequency
133	133MHz Max. Frequency
160	160MHz Max. Frequency

5919T	Low Skew TTL PLL Clock Driver with Integrated Loop Filter